



Product Change Notice

Notice: 110422A

Date: 22 MAR 2011

To Our Valued Customers:

We appreciate your use of V•I Chip products. Our commitment to customer satisfaction is demonstrated by our notification to you of a process change within a V•I Chip product.

Description:

V•I Chip products are multi-component assemblies using surface mount control IC, FETs, diodes, etc. The original process used an underfill material prior to over-molding. As part of our continuous improvement efforts, development work was undertaken to develop a process which uses the over-mold material in place of the previous under-fill material. The qualification report is available upon request.

Product(s) Affected / Schedule:

Part#	Description	Samples available	Mass Production Qualification	Production Shipments
B352F110T30	HV BCM 352 - 11V, 300W	Now	Now (from D/C 1105, 1-30-11)	Now (from D/C 1105, 1-30-11)
B352T110T30	HV BCM 352 - 11V, 300W	Now	Now (from D/C 1105, 1-30-11)	Now (from D/C 1105, 1-30-11)
B384F120T30	HV BCM 384 - 12V, 300W	Now	Now (from D/C 1105, 1-30-11)	Now (from D/C 1105, 1-30-11)
B384T120T30	HV BCM 384 - 12V, 300W	Now	Now (from D/C 1105, 1-30-11)	Now (from D/C 1105, 1-30-11)
V048F480T006	VTM 48 – 48V, 6A	Now	Now (from D/C 1105, 1-30-11)	Now (from D/C 1105, 1-30-11)
V048T480T006	VTM 48 – 48V, 6A	Now	Now (from D/C 1105, 1-30-11)	Now (from D/C 1105, 1-30-11)
V048F480M006	VTM 48 – 48V, 6A	Now	Now (from D/C 1105, 1-30-11)	Now (from D/C 1105, 1-30-11)
V048T480M006	VTM 48 – 48V, 6A	Now	Now (from D/C 1105, 1-30-11)	Now (from D/C 1105, 1-30-11)

Action Required:

No action required.

Technical Marketing contact:

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